

### High Surge Current Series - DO-214



#### Agency Approvals

Agency	Agency File Number
	E133083

#### Pinout Designation

Not Applicable

#### Schematic Symbol



#### Description

The High Surge Current DO-214 Series are SIDACtor® thyristors designed to protect equipment located in hostile environments from overvoltage transients.

The series provides a 200A 10/1000  $\mu$ s rated surface mount solution that enables equipment to comply with enhanced surge requirements now specified in regulatory and customer requirements.

#### Features and Benefits

- Low voltage overshoot
  - Low on-state voltage
  - Does not degrade surge capability after multiple surge events within limit.
  - Fails short circuit when surged in excess of ratings
  - 200A 10x1000 Surge
- Rating
- 1000A 2x10 Surge Rating
  - RoHS Compliant and Halogen-Free
  - Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

#### Applicable Global Standards

- TIA-968-A
- TIA-968-B
- ITU K.20/21/45 Enhanced Level
- ITU K.20/21/45 Basic Level
- GR 1089 Intra-building
- IEC 61000-4-5 2nd edition
- YD/T 1082
- YD/T 993
- YD/T 950
- GR 1089 Inter-building

#### Electrical Characteristics

Part Number	Marking	$V_{DRM}$ @ $I_{DRM}=5\mu A$	$V_s$ @ 100V/ $\mu$ s	$I_H$	$I_s$	$I_{T++}$	$V_T$ @ $I_T=2.2A$	Capacitance @ 1MHz, 2V bias	
		V min	V max	mA min	mA max	A max	V max	pf min	pF max
P0080SDLRP	P-8D	6	25	50	800	2.2	4	50	150
P0640SDLRP	P06D	58	77	50	800	2.2	4	100	160
P0720SDLRP	P07D	65	88	50	800	2.2	4	100	150
P0900SDLRP	P09D	75	98	50	800	2.2	4	95	140
P1100SDLRP	P11D	90	130	50	800	2.2	4	75	115
P1300SDLRP	P13D	120	160	50	800	2.2	4	65	100
P1500SDLRP	P15D	140	180	50	800	2.2	4	60	90
P1800SDLRP	P18D	170	220	50	800	2.2	4	50	90
P2300SDLRP	P23D	190	260	50	800	2.2	4	50	80
P2600SDLRP	P26D	220	300	50	800	2.2	4	50	75
P3100SDLRP	P31D	275	350	50	800	2.2	4	45	70
P3500SDLRP	P35D	320	400	50	800	2.2	4	45	65

Notes:

- Absolute maximum ratings measured at  $T_a = 25^\circ C$  (unless otherwise noted).

- Components are bi-directional (unless otherwise noted).

\*\* Will meet 4.4A power cross requirement without fire hazard.

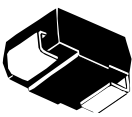
**Surge Ratings**

Series	$I_{PP}$									$I_{TSM}$ 50/60 Hz	di/dt
	0.2/310 <sup>1</sup>	2/10 <sup>1</sup>	8/20 <sup>1</sup>	10/160 <sup>1</sup>	10/560 <sup>1</sup>	5/320 <sup>1</sup>	10/360 <sup>1</sup>	10/1000 <sup>1</sup>	5/310 <sup>1</sup>		
	0.5/700 <sup>2</sup>	2/10 <sup>2</sup>	1.2/50 <sup>2</sup>	10/160 <sup>2</sup>	10/560 <sup>2</sup>	9/720 <sup>2</sup>	10/360 <sup>2</sup>	10/1000 <sup>2</sup>	10/700 <sup>2</sup>		
	A min	A min	A min	A min	A min	A min	A min	A min	A min	A min	A/μs max
D	—	1000	800	—	—	—	—	200	350	50	1000

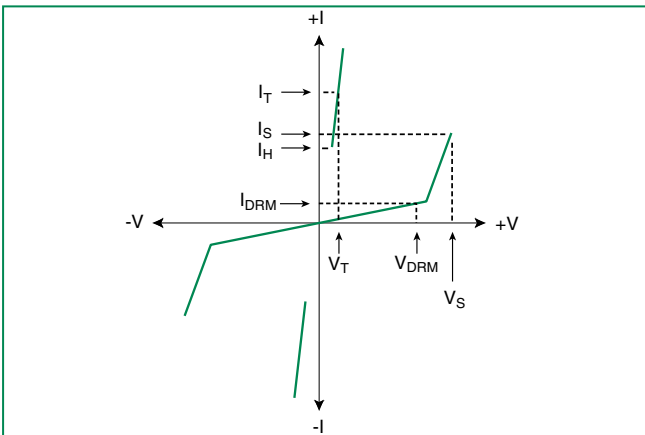
Notes:

- 1 Current waveform in μs
- 2 Voltage waveform in μs
- Peak pulse current rating ( $I_{pp}$ ) is repetitive and guaranteed for the life of the product that remains in thermal equilibrium.
- $I_{pp}$  ratings applicable over temperature range of -40°C to +85°C
- The component must initially be in thermal equilibrium with -40°C ≤  $T_J$  ≤ +150°C

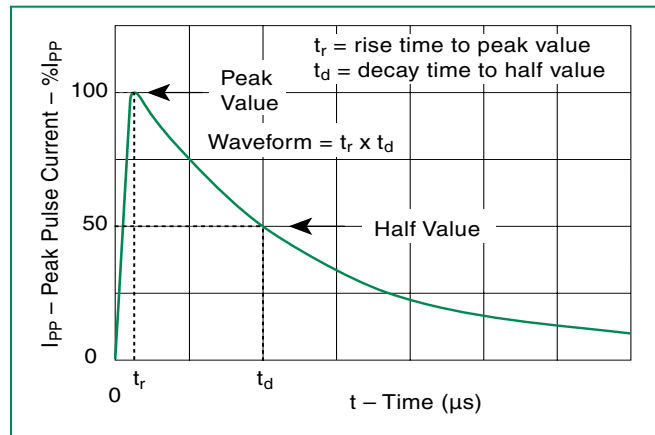
**Thermal Considerations**

Package	Symbol	Parameter	Value	Unit
DO-214AA 	$T_J$	Operating Junction Temperature Range	-40 to +150	°C
	$T_S$	Storage Temperature Range	-65 to +150	°C
	$R_{\theta JA}$	Thermal Resistance: Junction to Ambient	90	°C/W

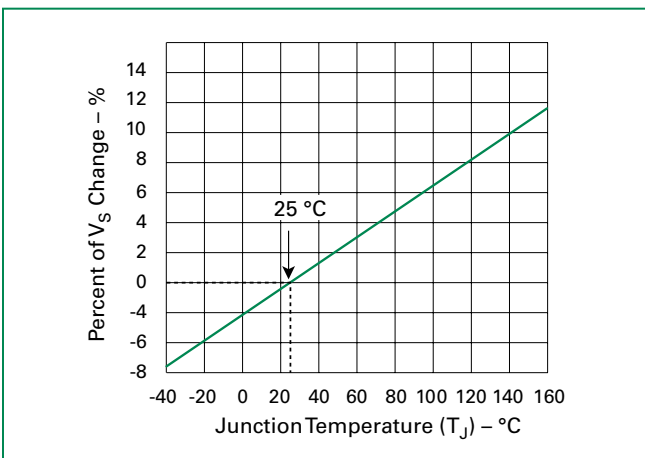
**V-I Characteristics**



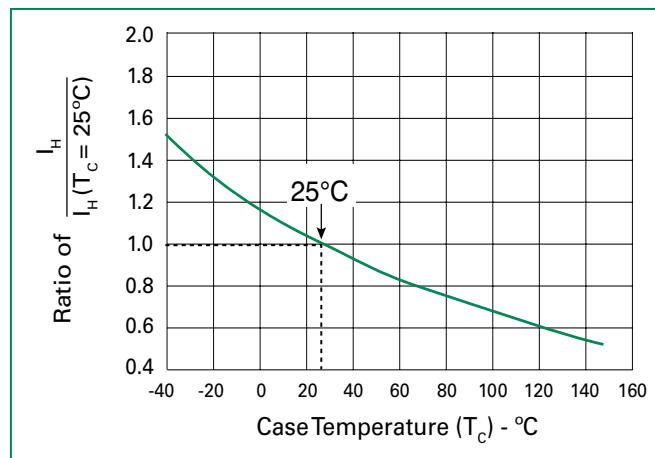
**$t_r \times t_d$  Pulse Waveform**



**Normalized  $V_S$  Change vs. Junction Temperature**

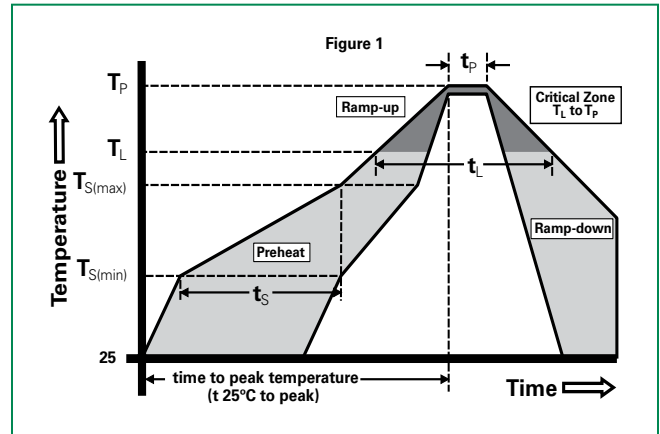


**Normalized DC Holding Current vs. Case Temperature**



## Soldering Parameters

Reflow Condition	Pb-Free assembly (see Fig. 1)	
Pre Heat	-Temperature Min ( $T_{s(min)}$ )	+150°C
	-Temperature Max ( $T_{s(max)}$ )	+200°C
	-Time (Min to Max) ( $t_s$ )	60-180 secs.
Average ramp up rate (Liquidus Temp ( $T_L$ ) to peak)	3°C/sec. Max.	
$T_{s(max)}$ to $T_L$ - Ramp-up Rate	3°C/sec. Max.	
Reflow	-Temperature ( $T_L$ ) (Liquidus)	+217°C
	-Temperature ( $t_L$ )	60-150 secs.
Peak Temp ( $T_p$ )	+260(+0/-5)°C	
Time within 5°C of actual PeakTemp ( $t_p$ )	30 secs. Max.	
Ramp-down Rate	6°C/sec. Max.	
Time 25°C to Peak Temp ( $T_p$ )	8 min. Max.	
Do not exceed	+260°C	



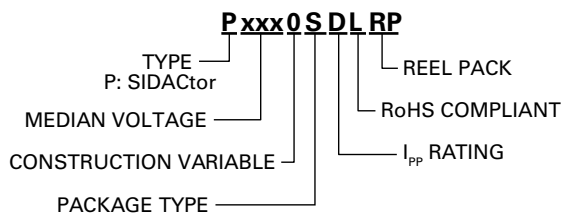
## Physical Specifications

Lead Material	Copper Alloy
Terminal Finish	100% Matte-Tin Plated
Body Material	UL Recognized epoxy meeting flammability classification V-0 per Underwriters Laboratories

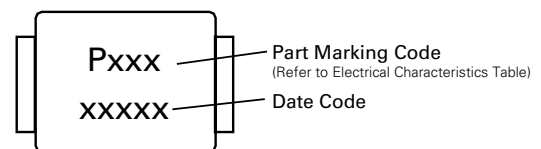
## Environmental Specifications

High Temp Voltage Blocking	80% Rated $V_{DRM}$ ( $V_{AC Peak}$ ) +125°C or +150°C, 504 or 1008 hrs. MIL-STD-750 (Method 1040) JEDEC, JESD22-A-101
Temp Cycling	-65°C to +150°C, 15 min. dwell, 10 up to 100 cycles. MIL-STD-750 (Method 1051) EIA/JEDEC, JESD22-A-104
Biased Temp & Humidity	52 $V_{DC}$ (+85°C) 85%RH, 504 up to 1008 hrs. EIA/JEDEC, JESD22-A-101
High Temp Storage	+150°C 1008 hrs. MIL-STD-750 (Method 1031) JEDEC, JESD22-A-101
Low Temp Storage	-65°C, 1008 hrs.
Thermal Shock	0°C to +100°C, 5 min. dwell, 10 sec. transfer, 10 cycles. MIL-STD-750 (Method 1056) JEDEC, JESD22-A-106
Autoclave (Pressure Cooker Test)	+121°C, 100%RH, 2atm, 24 up to 168 hrs. EIA/JEDEC, JESD22-A-102
Resistance to Solder Heat	+260°C, 30 secs. MIL-STD-750 (Method 2031)
Moisture Sensitivity Level	85%RH, +85°C, 168 hrs., 3 reflow cycles (+260°C Peak). JEDEC-J-STD-020, Level 1

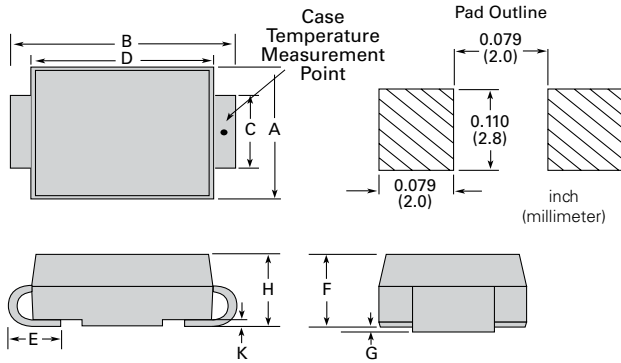
## Part Numbering



## Part Marking



**Dimensions – DO-214AA**

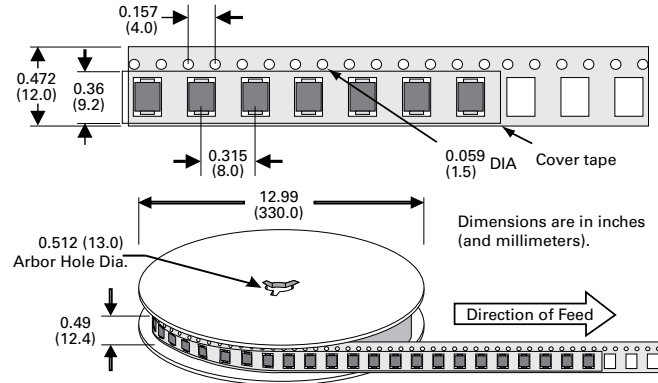


Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.130	0.156	3.30	3.95
B	0.201	0.220	5.10	5.60
C	0.077	0.087	1.95	2.20
D	0.159	0.181	4.05	4.60
E	0.030	0.063	0.75	1.60
F	0.075	0.096	1.90	2.45
G	0.002	0.008	0.05	0.20
H	0.077	0.104	1.95	2.65
K	0.006	0.016	0.15	0.41

**Packing Options**

Package Type	Description	Quantity	Added Suffix	Industry Standard
S	DO-214AA Tape and Reel Pack	2500	RP	EIA-481-D

**Tape and Reel Specification – DO-214AA**



**Additional Information**



**Datasheet**



**Resources**



**Samples**